

**CHIPS  
ALLIANCE**

**April 19, 2022**

# **Chiplet Protocol IP**

**David Kehlet, Intel**

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How can we make it easier to build  
chipselets and multi-chip package  
devices?

How can we advance the state of the  
art in chipselet design?

# Outline

- › Die-to-Die Interfaces: AIB 2.0, UCIe
- › New Chiplet SPI Open Source Hardware IP
- › New Chiplet AXI Open Source Hardware IP

# US Government SHIP Program

intel. newsroom

October 2, 2020

**The News:** The U.S. Department of Defense has awarded Intel Federal LLC the second phase of its State-of-the-Art Heterogeneous Integration Prototype (SHIP) program. The SHIP program enables the U.S. government to access Intel's state-of-the-art semiconductor packaging capabilities.

SHIP includes developing chiplet interface standards and protocols

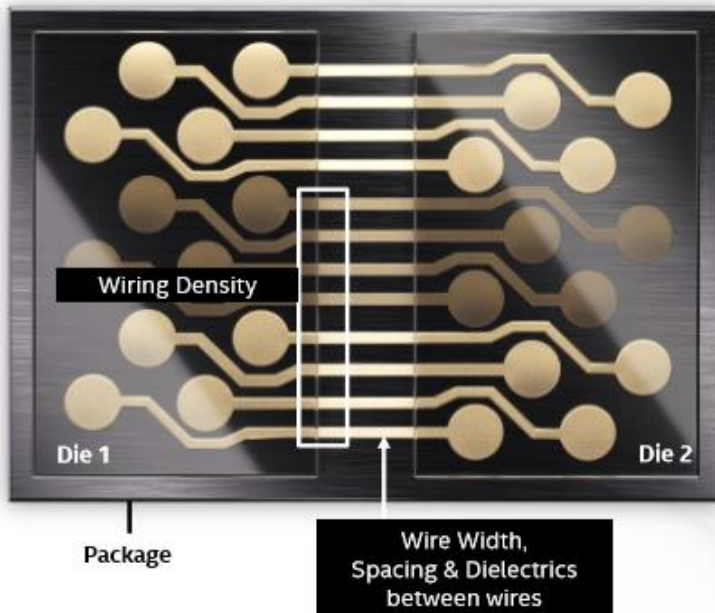
Chiplet AXI and SPI IP are being used in a SHIP Proof of Concept chiplet and Multi-Chip Package



# AIB 2.0: A Second Generation Die-to-Die Interface

## Enabling an Ecosystem

High density die-to-die interconnects



Feature	AIB 1.0	AIB 2.0
Bandwidth/wire (Gbps)	2	Up to 6.4
Bump density (um)	55	55/45/36
Bandwidth/mm shoreline (Gbps/mm)	256	1638
IO Voltage (V)	0.90	0.90/0.40
Energy/bit (pJ/bit)	0.85	0.50
Backward Compatibility	n/a	1.0

AIB Generator available at:  
[github.com/chipsalliance](https://github.com/chipsalliance)



# AIB 2.0: A Second Generation Die-to-Die Interface

2.0 Spec at

<https://github.com/chipsalliance/AIB-specification>

2.0 RTL at

<https://github.com/chipsalliance/aib-phy-hardware/v2.0>



**Advanced Interface Bus (AIB)  
Specification**

Feature	AIB 1.0	AIB 2.0
Bandwidth/wire (Gbps)	2	Up to 6.4
Bump density (um)	55	55/45/36
Bandwidth/mm shoreline (Gbps/mm)	256	1638
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AIB Generator available at:  
[github.com/chipsalliance](https://github.com/chipsalliance)

# Universal Chiplet Interconnect Express (UCIe)



## UCIe

Universal Chiplet  
Interconnect Express

— Building an open  
ecosystem of chiplets  
for on-package  
innovations

### PRESS RELEASES

[Leaders in semiconductors, packaging, IP suppliers, foundries, and cloud service providers join forces to standardize chiplet ecosystem](#) -

Beaverton, OR, USA / March 2, 2022

- › UCIe KPIs include per-wire rates up to 32Gbps
- › UCIe specification will include details on interoperation with AIB-based chiplets
- › Each UCIe participant determines their own product roadmap and availability
- › Request the specification from the UCIe Consortium:  
<https://www.uciexpress.org/specification>





# Intel & UCle

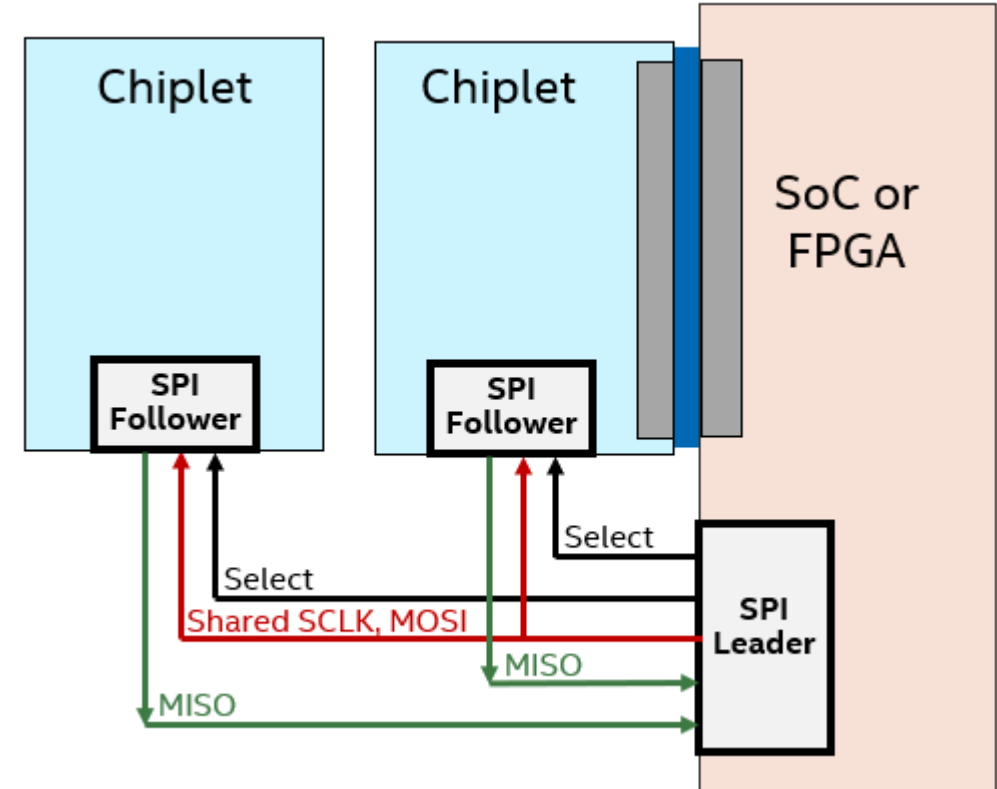
- Q: Will Intel continue to develop products using the current AIB specification?
- A: Yes, new products will use today's AIB interface, along with several being developed in concert with the US Government State-of-the-Art Heterogeneous Integration Prototype (SHIP) program.
- Q: Will UCle support AIB?
- A: Yes, the UCle specification will include details on how UCle implementations can interoperate with AIB-based chiplets, enabling AIB-based chiplets to join and contribute value to the UCle chiplet ecosystem.
- Q: What are Intel's plans for AIB going forward?
- A: Intel is committed to UCle and we will migrate AIB applications to UCle eventually. The latest AIB 2.0 specification is being used now by developers for new chiplets. We do not expect any new spec development beyond AIB 2.0 given the UCle path. We expect that many AIB developers will benefit from and seek to transition to UCle to take full advantage of the improved KPIs. Developers using UCle will be able to take advantage of UCle/AIB super-set PHY to access the AIB chiplet ecosystem.



# Chiplet SPI IP

# Chiplet SPI IP

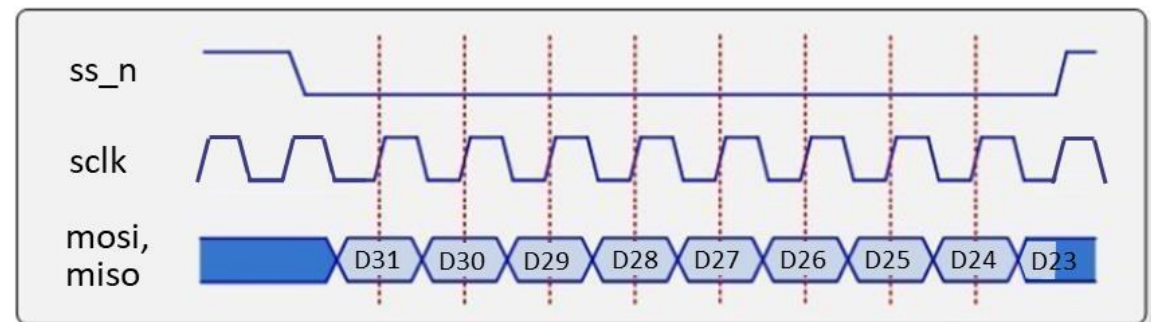
- Chiplet SPI IP is a simple protocol on top of SPI signaling
  - SPI is widely used for ADC/DACs, peripherals
- Chiplet SPI IP fills a general need for chiplet control, configuration and status
- Providing both SPI Leader (FPGA, ASIC or SoC) and SPI Follower (Chiplet) IP modules
  - Chiplet SPI Follower plugs in to AIB Hard Macro for AIB configuration, *and*
  - Chiplet SPI Follower plugs in to chiplet control and status register application



# Chiplet SPI Die-to-Die Signals

- Leader supports up to 4 Followers
  - 4 select lines `ss_n[3:0]`
  - Separate `miso[3:0]` lines for ease of debugging
- `mosi` and `miso` are in 32b DWORD quantities
- Simple, right?
- The trick with SPI is framing of commands and data

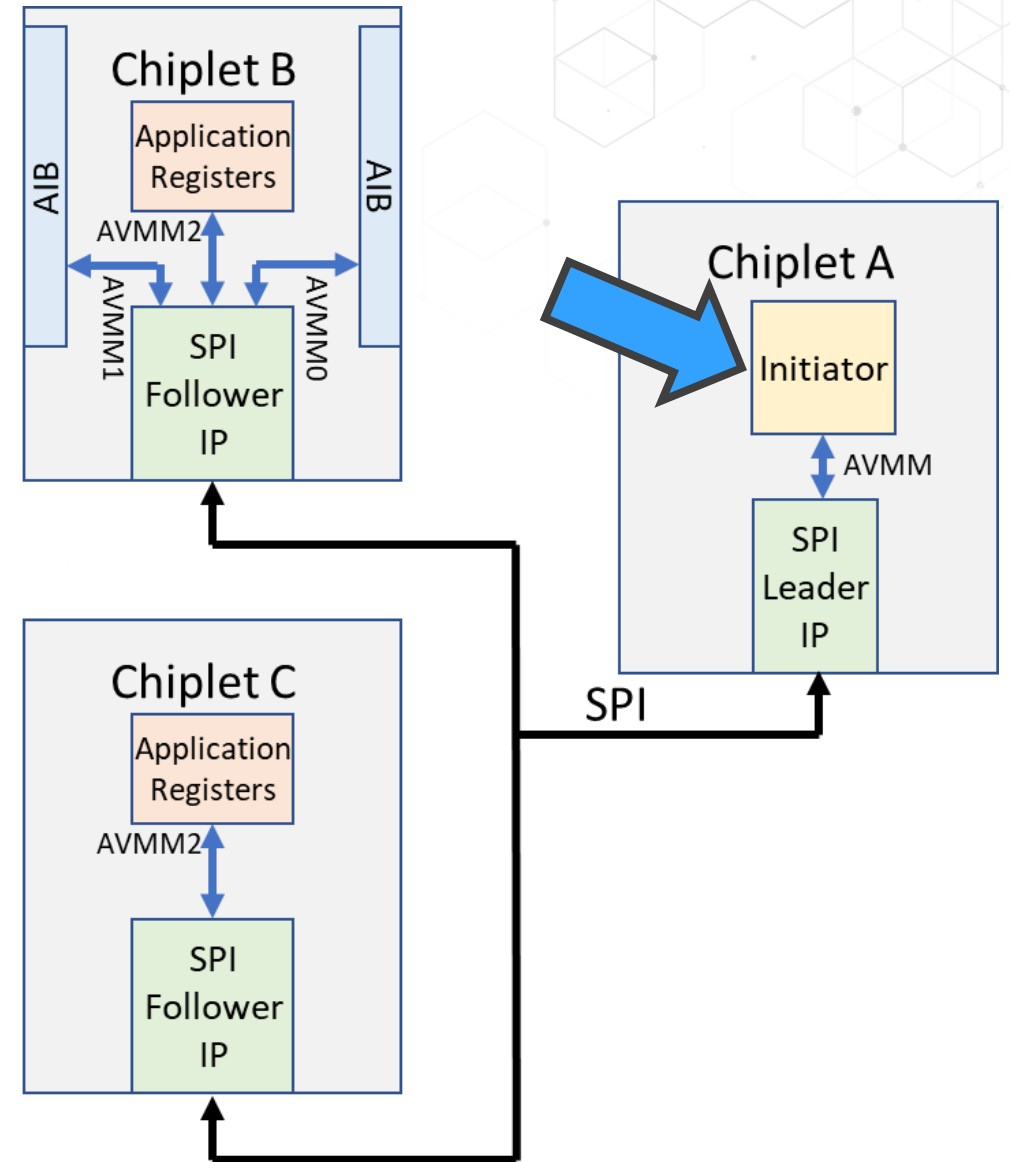
Leader SPI IO Ports	In/ Out	Width	Description
<code>sclk</code>	out	1	SPI serial clock from SPI leader. The SPI IP operates with a continuous <code>sclk</code> .
<code>ss_n[3:0]</code>	out	4	Follower select. Active low means the follower access is enabled. High means the follower is not enabled. The SPI Leader can support up to four SPI Followers.
<code>mosi</code>	out	1	Leader out, follower in
<code>miso[3:0]</code>	in	4	Leader in, follower out. The SPI Leader accepts separate <code>miso</code> lines for up to four SPI Followers.



Chiplet SPI IP Supports SPI Mode0

# Chiplet SPI IP Interfaces

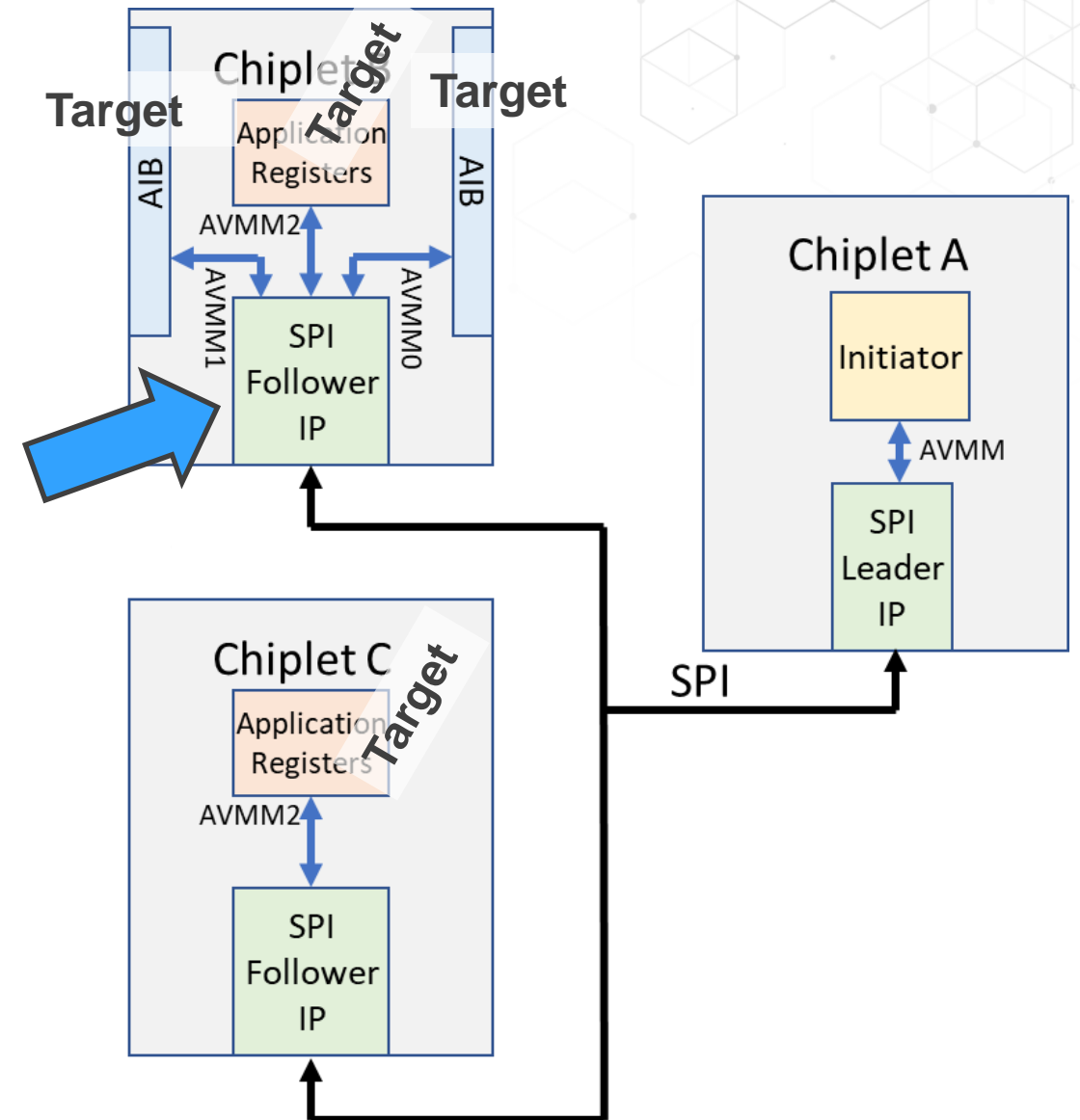
- Roles:
  - Initiator (RTL or microcontroller) starts all actions
  - SPI Leader IP (“Leader”)
  - SPI Follower IP (“Follower”)
  - Targets (AIB, Application Registers, other)
- Initiator drives the SPI Leader
  - Simple addressed read/write interface with 32b wdata, rdata





# Chiplet SPI IP Interfaces

- Objective: Writes and reads to Follower Targets
- Follower has three interfaces to Targets
- Typical targets:
  - AIB PHY control and status registers (see <https://github.com/chipsalliance/aib-phy-hardware> )
  - General purpose chiplet control and status register block (see [https://github.com/chipsalliance/aib-protocols/blob/main/spi-aib/rtl/app\\_avmm\\_csr.sv](https://github.com/chipsalliance/aib-protocols/blob/main/spi-aib/rtl/app_avmm_csr.sv) )



# Chiplet SPI IP on GitHub

- Chiplet SPI User Guide:
- [https://github.com/chipsalliance/aib-protocols/blob/main/spi-aib/doc/Chiplet\\_SPI\\_User\\_Guide\\_v1\\_0.pdf](https://github.com/chipsalliance/aib-protocols/blob/main/spi-aib/doc/Chiplet_SPI_User_Guide_v1_0.pdf)

A screenshot of the GitHub repository page for 'chipsalliance / aib-protocols'. The repository is public and has 7 issues, 0 pull requests, and 35 commits. The file tree shows several directories: 'axi4-mm', 'axi4-st', 'backup/spi', 'ca', 'common', 'llink', 'lpif', and 'spi-aib'. The 'spi-aib' directory is highlighted with a yellow box. Below the file tree, there are two files: 'CHIPS Alliance - CCLA v7.pdf' and 'LICENSE'. The 'spi-aib' directory is the focus of the presentation, as indicated by the arrow from the title and the list of links.

Search or jump to... / Pull requests Issues Marketplace Explore

chipsalliance / aib-protocols Public

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main 1 branch 0 tags Go to file Add file Code

johna-eximiusdesign "release 0.9.2 ... 2b3d47f 9 days ago 35 commits

axi4-mm	"release 0.9.2	9 days ago
axi4-st	"release 0.9.2	9 days ago
backup/spi	Move spi to backup directory	23 days ago
ca	"release 0.9.2	9 days ago
common	"release 0.9.2	9 days ago
llink	"release 0.9.2	9 days ago
lpif	"release 0.9.2	9 days ago
spi-aib	Added Application Register block and it's DV test. Rev 1.2 release	10 days ago
CHIPS Alliance - CCLA v7.pdf	Added blank corporate contributor license agreement	6 months ago
LICENSE	IP directories	5 months ago



# AXI4 Protocol IP

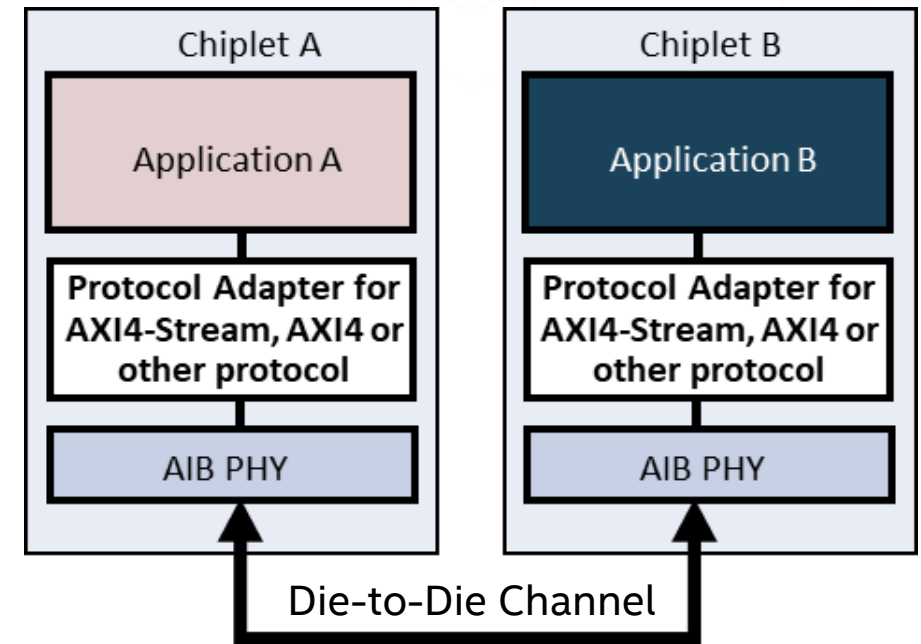
# AXI4 Protocols for Chiplet Interoperability

Protocols are the next area of interoperability after the PHY

- › The “Data Link” layer in the OSI reference model

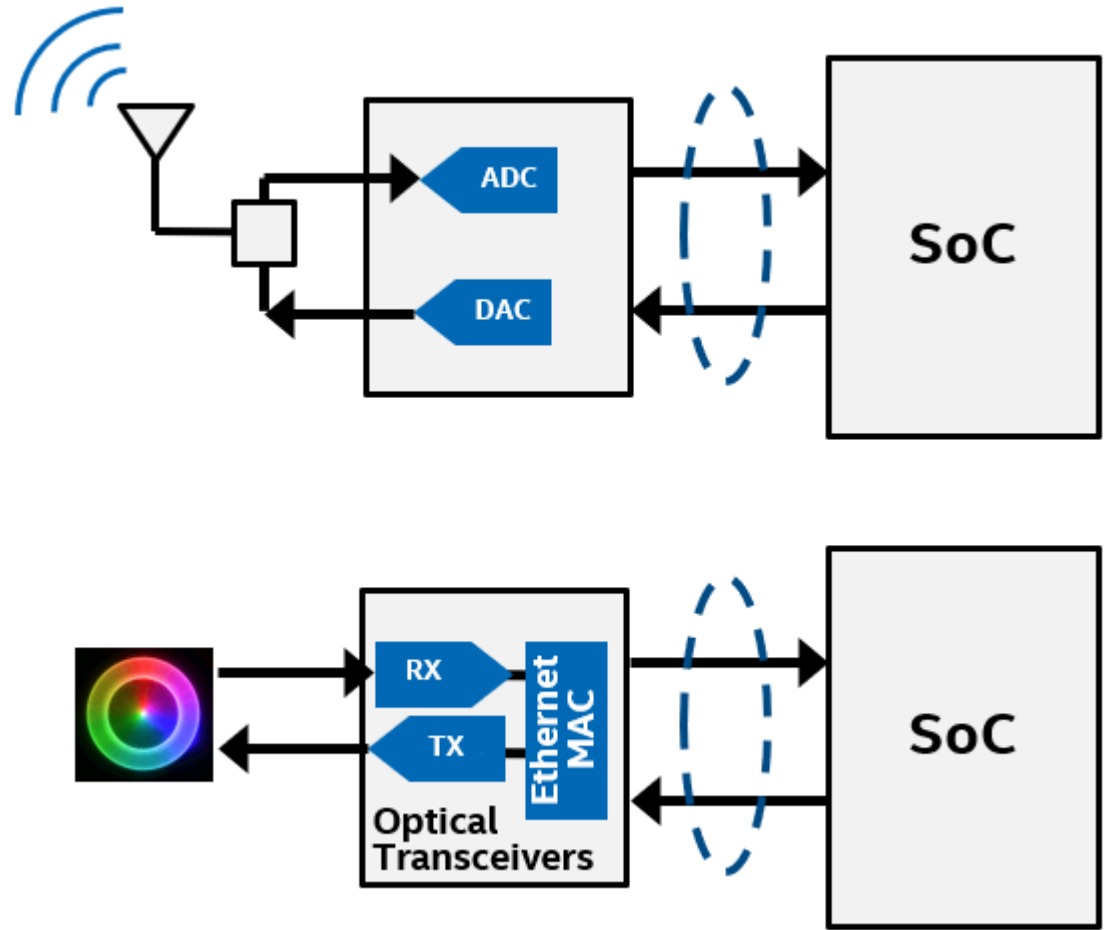
Protocol adapters on each side convert the protocol interface to the AIB PHY data wires

- › Both chiplets need to know how a protocol is mapped to the wires
- › Providing adapter IP for both sides makes sure the mapping is understood



# Chiplet Protocols: AXI4-Stream

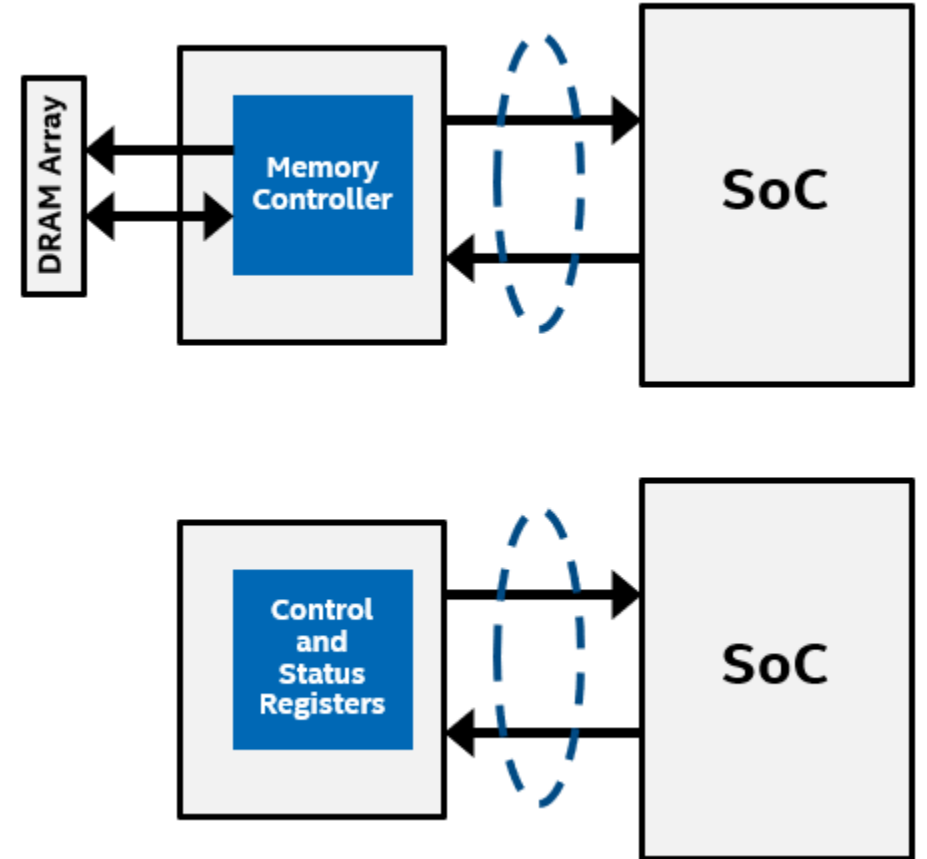
- Streaming Applications
    - Parallel data width varies by application
    - High utilization/efficiency and Low latency
    - Data usually arrives every clock
- Looks like AXI4 Stream!



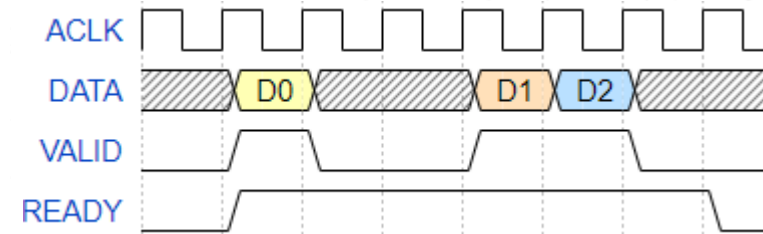
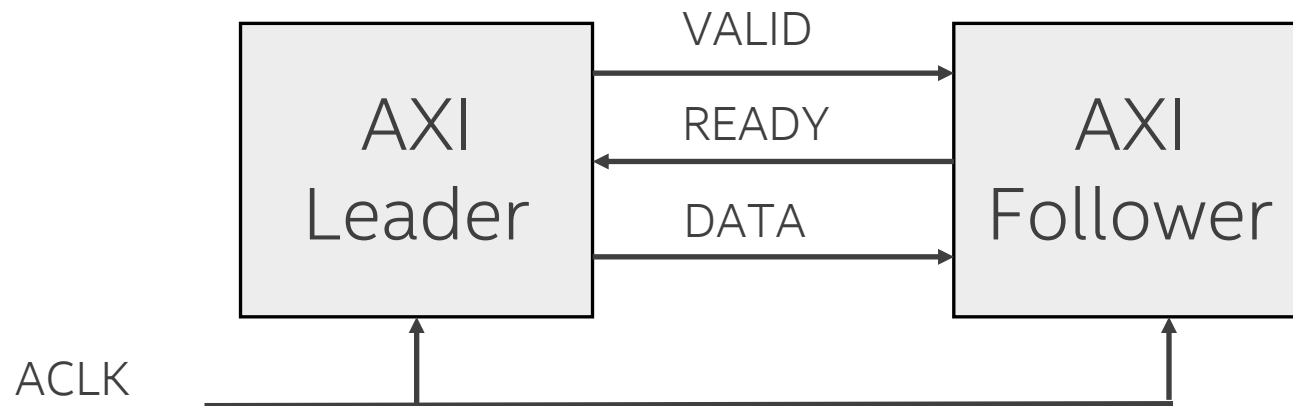


# Chiplet Protocols: AXI4, AXI4-Lite

- Memory applications
  - Read and write transactions
  - High utilization/efficiency and Low latency
  - Looks like AXI4!
- Control and Status Registers applications
  - Moderate performance requirements
  - Looks like AXI4-lite!

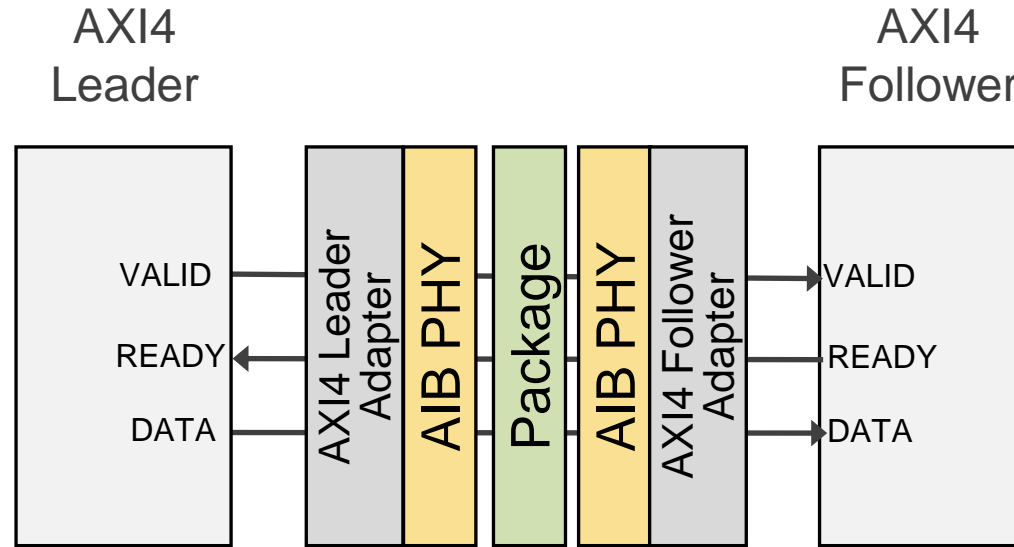


# AXI4 Valid/Ready Flow Control Basics



- › Leader asserts and holds VALID when data is available
- › Follower asserts READY if able to accept data

# AXI4 over AIB



Leader must react to the follower's READY within the same cycle that READY is asserted.

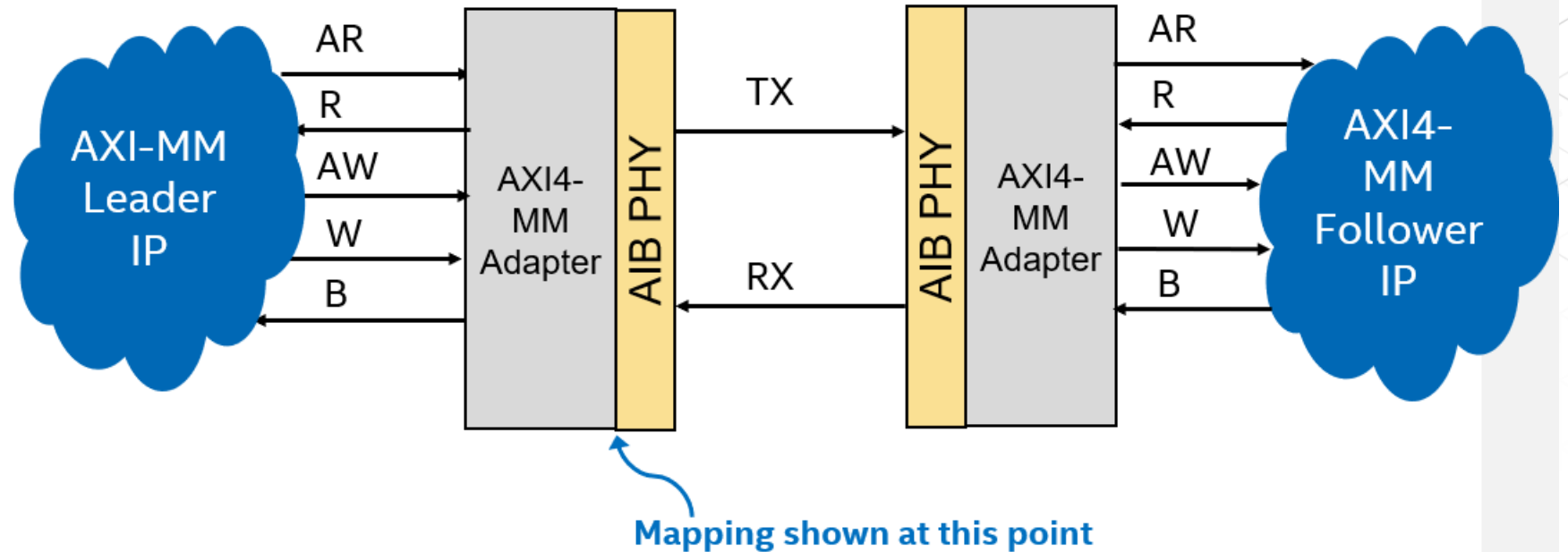
Straight AXI4 does not work for die-to-die:

- › Clock phase difference between leader and follower
- › Pipeline delays crossing between leader and follower

Need adapters for AXI4 die-to-die operation, to allow for phase delays & pipeline delays

- › Adapters implement a credit scheme: Leader can send when a credit is available, Follower returns a credit when a follower entry is vacated

# AXI4 Mapping Over AIB



	79	78	77	76	73	72	71	68	65			17	16		14	13	7	6	5	4	3	2	1	0			
aw	header=1		r	b	awpush=1	Rsvd	Rsvd	Rsvd	Rsvd	awaddr[47:0]			awsiz[2:0]=011			awlen[7:0]=0			awburst[1:0]=1		awid[3:0]						
w_0	header=2		r	b	wpush=1	Rsvd	Rsvd	wl=1	wdata[63:0]															wid[3:0]			

Simple example: 64b data bus over a AIB2.0 Gen2 channel at full rate

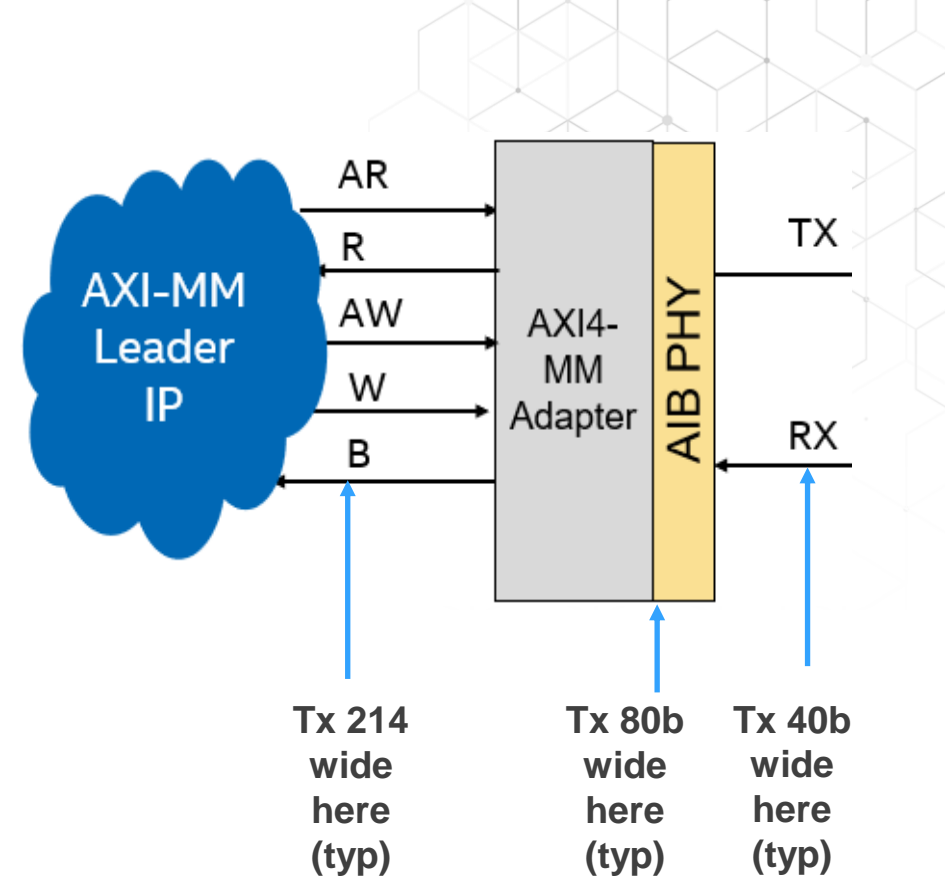
- › awpush and wpush are “valid” indicators and use up credits in the adapter
- › Write response comes back the other way with credit bits

# Benefit of Packetizing AXI4

- › The AXI4 Adapter packetizes the AXI4 transmit channels AR, AW, W to share the AIB's Tx wires
- › Alternatively, one could just fold the AXI4 wires onto Tx
- › Compare the results for Packetizing vs. Folding

Case	Packetizing: Full Rate Cycles at Input to AIB PHY	Folding: Full Rate Cycles at Input to AIB PHY
64b Write Single	2	3
64b Write Burst of 4	5	12
64b Write Burst of 64	65	192

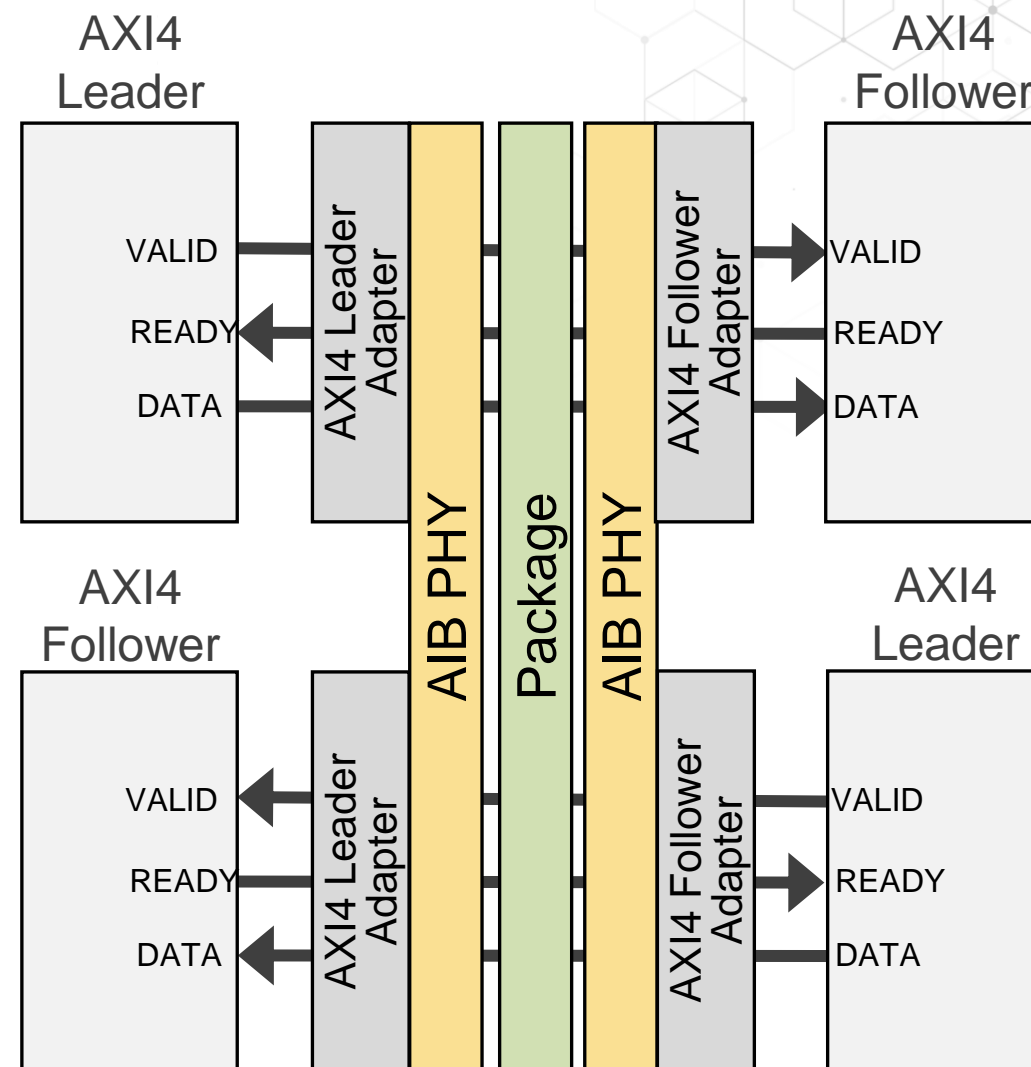
- › Packetizing is much more efficient!
- › When AXI4 is between two modules on the same die, the low utilization of wires is not significant since on-die wire width is up to 20x smaller than advanced packaging (e.g. 100nm on-die vs. 2um advanced packaging)
- › Asymptotically achieves 80% efficiency for a 64bit AXI4 interface (80% = 64b AXI / 80b AIB)





# Chiplet Protocols: AXI4-Stream Interface Packing

- Our AXI4-Stream IP will pack an AXI4-Stream leader/follower pair **in each direction** to maximize AIB channel utilization



# AXI4 IP on GitHub

GitHub interface showing the repository **chipsalliance / aib-protocols** (Public).

Navigation tabs: Code, Issues (7), Pull requests, Discussions, Actions, Projects, Wiki, Security.

Repository details: main branch, 1 branch, 0 tags. Buttons: Go to file, Add file, Code.

Commit history by **johna-eximiusdesign** (release 0.9.2, 2b3d47f, 9 days ago, 35 commits):

File/Folder	Commit Message	Time Ago
axi4-mm	"release 0.9.2"	9 days ago
axi4-st	"release 0.9.2"	9 days ago
backup/spi	Move spi to backup directory	23 days ago
ca	"release 0.9.2"	9 days ago
common	"release 0.9.2"	9 days ago
llink	"release 0.9.2"	9 days ago
lpif	"release 0.9.2"	9 days ago
spi-aib	Added Application Register block and it's DV test. Rev 1.2 release	10 days ago
CHIPS Alliance - CCLA v7.pdf	Added blank corporate contributor license agreement	6 months ago
LICENSE	IP directories	5 months ago

# Conclusion

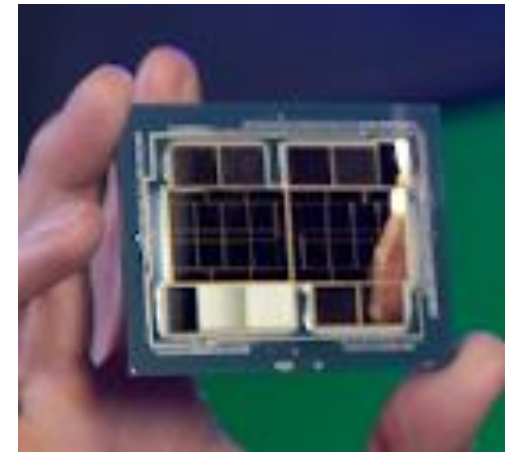
*"It may prove to be more economical to build large systems out of smaller functions, which are separately packaged and interconnected<sup>1</sup>."*

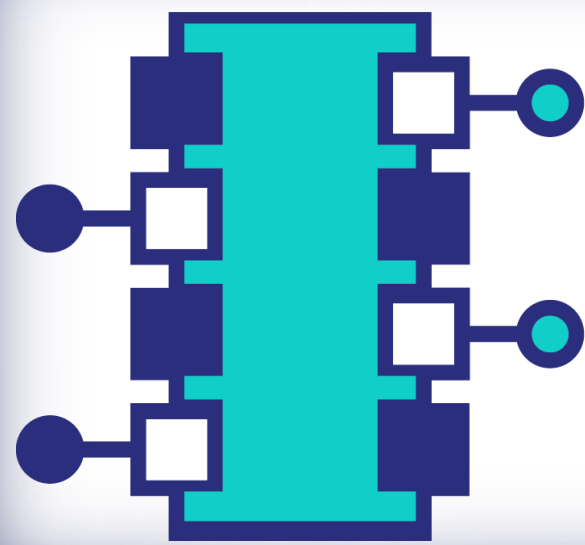
-Gordon E. Moore

1: 3rd Page of Moore's 1965 paper, "Cramming More Components onto Integrated Circuits"



- › Chiplets are being used to build larger systems – *just as Gordon Moore predicted!*
- › Advancing chiplet interoperability with open source hardware protocol RTL





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Backup



# Channel Alignment IP

Data distributed over multiple AIB channels will arrive at different times due to skew

Using a “Strobe” bit per channel, a Channel Alignment function can deskew the data

Included with the AXI4 and AXI4-Stream open source hardware IP

